

NCE P-Channel Super Trench Power MOSFET



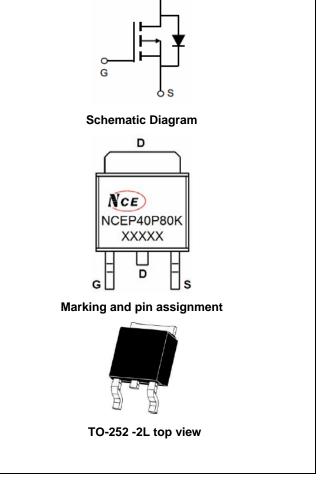
The NCEP40P80K uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

- **General Features**
- V_{DS} =-40V,I_D =-80A
 R_{DS(ON)}=5.6mΩ (typical) @ V_{GS}=-10V
 R_{DS(ON)}=7.6mΩ (typical) @ V_{GS}=-4.5V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED! 100% ΔVds TESTED!



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Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP40P80K	NCEP40P80K	TO-252-2L	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	-40	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	ID	-80	А	
Drain Current-Continuous(T _C =100 ℃)	I _D (100℃)	-56	А	
Pulsed Drain Current	I _{DM}	-320	А	
Maximum Power Dissipation	PD	150	W	
Derating factor		1	W/°C	
Single pulse avalanche energy (Note 5)	E _{AS}	500	mJ	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C	



Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	1.0	°C/W
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Electrical Characteristics (T_C=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-40		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	I					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$,I _D =-250µA	-0.8	-1.2	-1.8	V
Drain Osuma Or Otata Dagistaria		V _{GS} =-10V, I _D =-20A	-	5.6	6.2	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =-4.5V, I _D =-20A	-	7.6	9.1	mΩ
Forward Transconductance	g _{FS}	V _{DS} =-5V,I _D =-20A	-	30	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	<u>)</u>	-	3700	-	PF
Output Capacitance	C _{oss}	V_{DS} =-20V, V_{GS} =0V,	-	880	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	20	-	PF
Switching Characteristics (Note 4)	I					
Turn-on Delay Time	t _{d(on)}		-	10.5	-	nS
Turn-on Rise Time	tr	V _{DD} =-20V,I _D =-20A	-	4	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{G} =1.6 Ω	-	35	-	nS
Turn-Off Fall Time	t _f		-	5	-	nS
Total Gate Charge	Qg	N/ 00)// 00A	-	57	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-20V, I_{D} =-20A,	-	9.8		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	7.3		nC
Drain-Source Diode Characteristics	· ·			I		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-20A	-		-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-80	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F =-20A	-		24	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	_		68	nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t \leq 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300 μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^\circ C$,V_DD=-20V,V_G=-10V,L=0.5mH,Rg=25 Ω



. V_{gs}=4.5V I_p=-20A

125

150

175

100

75

30

С

0.4

40

50

60

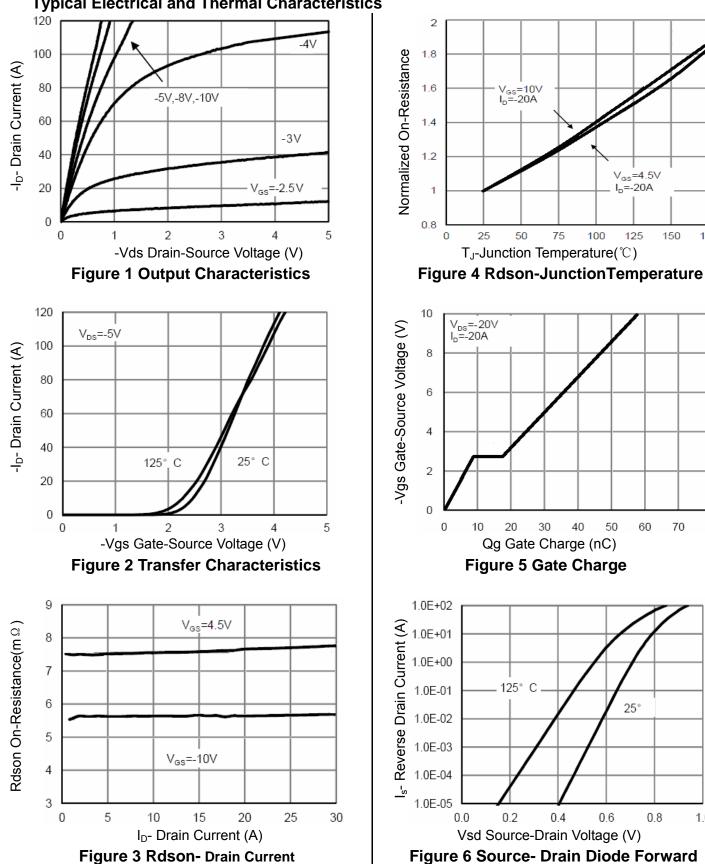
25°

0.8

0.6

70

80



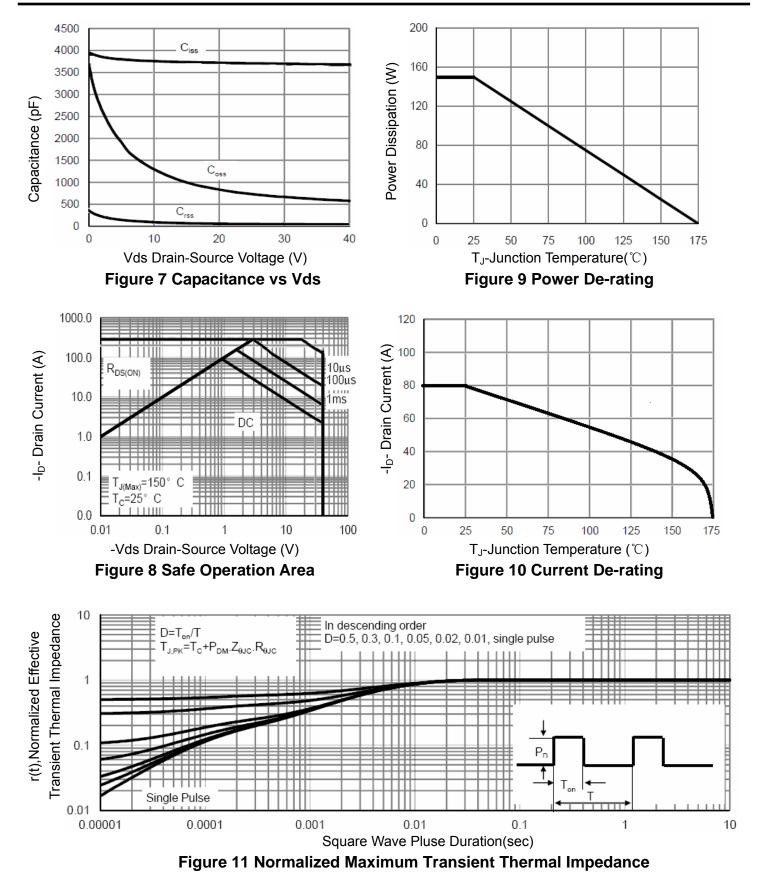
Typical Electrical and Thermal Characteristics

1.0



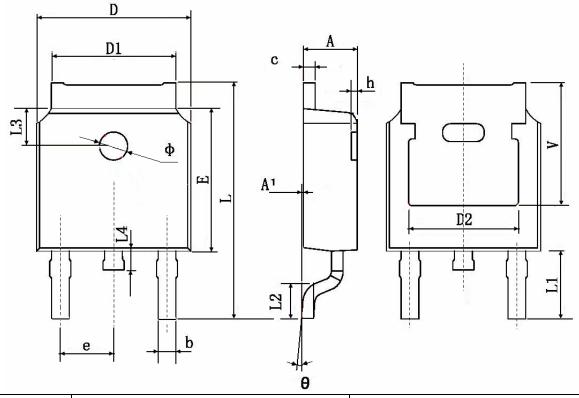
http://www.ncepower.com

NCEP40P80K





TO-252-2L Package Information



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.83	TYP.	0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900	2.900 TYP.		TYP.	
L2	1.400	1.700	0.055	0.067	
L3	1.600	0 TYP. 0.063 TYP.		TYP.	
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	TYP.	0.211 TYP.		



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